



DATA SHEET

SURFACE-MOUNT CERAMIC MULTILAYER CAPACITORS High-voltage SC type: NP0/X7R X1/Y2 & X2/Y3 2 pF to 1.5 nF



YAGEO Phícomp

2 Product specification 10

SCOPE

This specification describes safety certification NP0/X7R series chip capacitors with lead-free terminations.

APPLICATIONS

- PCs, Notebook
- Networking
- Power supplies

FEATURES

- Supplied in tape on reel
- Nickel-barrier end termination
- **RoHS** compliant
- Halogen Free compliant

ORDERING INFORMATION-GLOBAL PART NUMBER, PHYCOMP CTC & <u>12NC</u>

All part numbers are identified by the series, size, tolerance, TC material, packing style, voltage, process code, termination and capacitance value. Please note that 12 digits ordering code will expire at the end of 2010.

YAGEO BRAND ordering codes

GLOBAL PART NUMBER (PREFERRED)

SC	<u>xxxx</u>	<u>x</u>	<u>x</u>	<u>xxx</u>	<u>x</u>	В	<u>x</u>	<u>XXX</u>	
	(1)	(2)	(3)	(4)	(5)		(6)	(7)	

(I) SIZE – INCH BASED (METRIC)
1808 (4520)
1812 (4532)
(2) TOLERANCE
C = ±0.25 pF
$D = \pm 0.5 \text{ pF}$
$J = \pm 5\%$
K = ±10%
(3) PACKING STYLE
K = Blister taping reel; Reel 7 inch
(4) TC MATERIAL
NPO
X7R
(5) IMPULSE VOLTAGE

T = X2/Y3 for TUV/UL W= XI/Y2 for TUV/UL U = XI for UL (1812 X7R)

(6) PROCESS

N = NP0

B = Class 2 product

(7) CAPACITANCE VALUE

2 significant digits+number of zeros

The 3rd digit signifies the multiplying factor, and letter R is decimal point

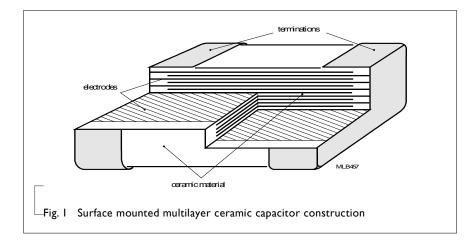
Example: $121 = 12 \times 10^{1} = 120 \text{ pF}$



CONSTRUCTION

The capacitor consists of a rectangular block of ceramic dielectric in which a number of interleaved metal electrodes are contained. This structure gives rise to a high capacitance per unit volume.

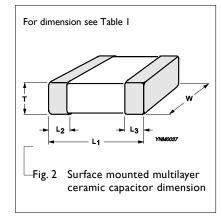
The inner electrodes are connected to the two end terminations and finally covered with a layer of plated tin (NiSn). The terminations are lead-free. A cross section of the structure is shown in Fig.1.



DIMENSION

Table I For outlines see fig. 2		
ТҮРЕ	SC1808	SC1812
Lı (mm)	4.8 ±0.30	4.8 ±0.30
W (mm)	2.0 ±0.30	3.2 ±0.30
T (mm)	Refer to table 2	to 3
L ₂ /L ₃ (mm) min.	0.25	0.25
	0.75	0.75

OUTLINES



Product specification

3 10



YAGEO	Phícomp		Product specification	4
				1

 $\frac{4}{10}$ Surface-Mount Ceramic Multilayer Capacitors Safety Certification NP0/X7R X1/Y2 & X2/Y3

CAPACITANCE RANGE & THICKNESS FOR NP0 X1/Y2 AND X2/Y3

Table 2 Sizes fro	m 1808 to 1812			
CAPACITANCE	1808, X1/Y2	1808, X1/Y2	1808, X2/Y3	1812, X1/Y2
	TUV	UL	TUV/UL	TUV/UL
15 pF				
18 pF				
22 pF				
27 pF				
33 pF	1.6±0.2	1.6±0.2		
39 _P F				1.6±0.2
47 _P F			1.6±0.2	
56 pF				
68 pF				
82 pF				
100 _P F				
120 pF				
150 pF		2.0±0.2		
180 pF				
220 pF	2.0±0.2			
240 pF				
270 _P F				2.0±0.2
330 _P F				
390 pF				
430 pF			2.0±0.2	
470 pF				
560 pF				
680 pF				
820 pF				
1000 pF				

ΝΟΤΕ

I. Values in shaded cells indicate thickness class in mm

2. Capacitance value of non E-12 series is on request



YAGEO	Phícomp			Product specification	5
	Surface-Mount Ceramic Multilayer Capacitors	Safety Certification	NP0/X7R	X1/Y2 & X2/Y3	10

CAPACITANCE RANGE & THICKNESS FOR X7R X1/Y2 AND X2/Y3

Table 3 Sizes fro	m 1808 to 1812			
CAPACITANCE	1808, X1/Y2 TUV/UL	1808, X2/Y3 TUV/UL	1812, X1/Y2 TUV	1812, XI UL
150 pF				
180 _P F	1.6±0.2			
220 pF		1.6±0.2		
240 pF				
270 pF			1.6±0.2	1.6±0.2
330 pF				
390 pF				
430 _P F	20.02			
470 pF	2.0±0.2			
560 pF				
680 pF			2.0±0.2	2.0±0.2
820 pF		2.0±0.2		
1.0 nF				
I.2 nF				
I.5 nF				

NOTE

THICKNESS CLASSES AND PACKING QUANTITY

Table 4			
DESCRIPTION	SIZE	THICKNESS CLASSIFICATION	12 mm TAPE WIDTH /AMOUNT PER REEL
	CODE	(mm)	Ø180 mm, 7" Blister
	1808	I.6 ±0.20	2,000
Safety Certification		2.0 ±0.20	2,000
Capacitor	1812	I.6 ±0.20	1,000
•		2.0 ±0.20	1,000



YAGEO	Phícomp			Product specification	16
	Surface-Mount Ceramic Multilayer Capacitors	Safety Certification	NP0/X7R	X1/Y2 & X2/Y3	10

ELECTRICAL CHARACTERISTICS

NP0/X7R DIELECTRIC CAPACITORS; NISN TERMINATIONS

Unless otherwise stated all electrical values apply at an ambient temperature of 20 ± 1 °C, an atmospheric pressure of 86 to 106 kPa, and a relative humidity of 63 to 67%.

Table !	5	
DESCRIPT	ΓΙΟΝ	VALUE
Capacitano	ce range	2 pF to 1.5 nF
Capacitan	ce tolerance	
NP0	C < 10 _P F	±0.25 pF, ±0.5 pF
	C ≥ 10 pF	±5%
X7R		±10%
Dissipatio	n factor (D.F.)	
NP0	C < 30 _P F	≤ I / (400 + 20C)
	$C \ge 30 \text{ pF}$	≤ 0.1 %
X7R		≤ 2.5 %
Insulation	resistance after 1 minute at U _r (DC)	$R_{ins} \ge 10 \text{ G}\Omega \text{ or } R_{ins} \times C \ge 500 \text{ seconds whichever is less}$
	capacitance change as a function of temperature ure characteristic/coefficient):	
NP0		±30 ppm/°C
X7R		±15%
	; temperature range:	
NP0/X7F	R	–55 °C to +125 °C

CAPACITOR REQUIREMENT

Table 6

SAFETY RATING	VOLTAGE RATING	WITHSTANDING VOLTAGE	IMPULSE VOLTAGE
XI	250 VAC	1,500 VAC	4,000 V
X2	250 VAC	1,500 VAC	2,500 V
Y2	250 VAC	1,500 VAC	5,000 V
Y3	250 VAC	1,500 VAC	

SOLDERING RECOMMENDATION

Table 7	7
---------	---

SOLDERING METHOD	SIZE 0402	0603	0805	1206	≥ 1210
Reflow	≥ 0.1µF	≥ 1.0 µF	≥ 2.2 µF	≥ 4.7 µF	Reflow only
Reflow/Wave	< 0.1µF	< 1.0 µF	< 2.2 µF	< 4.7 µF	



YAGEO	Phícomp			Product specification	7
	Surface-Mount Ceramic Multilayer Capacitors	Safety Certification	NP0/X7R	X1/Y2 & X2/Y3	10

TESTS AND REQUIREMENTS

Table 8 Test procedures and requirements						
TEST TEST METHOD		HOD	PROCEDURE	REQUIREMENTS		
Mounting	IEC 60384- 21/22	4.3	The capacitors may be mounted on printed-circuit boards or ceramic substrates	No visible damage		
Visual Inspection and Dimension Check		4.4	Any applicable method using × 10 magnification	In accordance with specification		
Capacitance		4.5.1	NP0: $f = I \text{ MHz}$ for $C \le I \text{ nF}$, measuring at voltage $I \text{ V}_{rms}$ at 20 °C; $f = I \text{ KHz}$ for $C > I \text{ nF}$, measuring at voltage $I \text{ V}_{rms}$ at 20 °C X7R: $f = I \text{ KHz}$ for $C \le I0 \mu\text{F}$, measuring at voltage $I \text{ V}_{rms}$ at 20 °C	Within specified tolerance		
Dissipation Factor (D.F.)		4.5.2	NP0: $f = I \text{ MHz}$ for $C \le I \text{ nF}$, measuring at voltage $I \text{ V}_{rms}$ at 20 °C; $f = I \text{ KHz}$ for $C > I \text{ nF}$, measuring at voltage $I \text{ V}_{rms}$ at 20 °C X7R: $f = I \text{ KHz}$ for $C \le I0 \mu\text{F}$, measuring at voltage $I \text{ V}_{rms}$ at 20 °C	In accordance with specification		
Insulation Resistance		4.5.3	To apply 500 V max for 60 seconds	In accordance with specification		

TEST	TEST MET	HOD	PROCED	URE	REQUIREMENTS
Temperature Characteristic		4.6	following The capac	ce shall be measured by the steps shown in the table. citance change should be measured after 5 min recified temperature stage.	<general purpose="" series=""> Class1: ∆ C/C: ±30ppm Class2:</general>
					X7R: Δ C/C: ±15%
			Step	Temperature(°C)	Y5V: ∆ C/C: 22~-82%
			a	25±2	<high capacitance="" series=""></high>
			Ь	Lower temperature±3°C	Class2: X7R/X5R: \triangle C/C: ±15%
			с	25±2	Y5V: Δ C/C: 22~-82%
			d	Upper Temperature±2°C	
			e	25±2	
			(1) Class	l i i i i i i i i i i i i i i i i i i i	
			formula a		
			Temp, Co	$efficient = \frac{C2 - C1}{C1x\Delta T} \times 10^6 \text{ [ppm/°C]}$	
			CI: Capa	citance at step c	
			C2: Capa	citance at 125°C	
			Δ Τ : 100°	C(=125°C-25°C)	
			(2) Class	П	
			Capacitance Change shall be calculated from the formula as below		
			$\Delta C = \frac{C2}{C}$	<u>- C1</u> × 100%	
			CI: Capacitance at step c		
			C2: Capa	citance at step b or d	
Adhesion 4.15		4.15	 a. A force applied for 10 seconds to the line joining the terminations and in a plane parallel to the substrate for size ≥ 0603 : a force of 5N applied 		No visible damage
				applied until broken ≥ 0603: ≥ 5N	
Bond Strength of	IEC 60384- 21/22	4.8	-	in accordance with IEC 60384-22 paragraph 4.3	No visible damage
Plating on			Conditions: bending 1 mm at a rate of 1 mm/s, radius jig		∆C/C
End Face			340 mm		NP0: ≤ 1% or 0.5 pF whichever is greater
					$X7R: \leq 10\%$
Resistance to Soldering		4.9		ion: 150 +0/–10 °C for 1 hour, then keep for Irs at room temperature	The termination shall be well tinned
Heat			Preheating	g: for size \leq 1206: 120 °C to 150 °C for 1	∆C/C
			minute		NP0: ≤ 0.5% or 0.5 pF
				g: for size >1206: 100 °C to 120 °C for 1 d 170 °C to 200 °C for 1 minute	whichever is greater X7R: ≤ 10%
				th temperature: 260 ±5 °C	
				me: 10 ±0.5 seconds	D.F. within initial specified value
			- -	24.121	R _{in} , within initial specified value

Recovery time: 24 ±2 hours

Jan. 27, 2015 V.6

 \mathbf{R}_{ins} within initial specified value

Surface-Mount Ceramic Multilayer Capacitors Safety Certification NP0/X7R X1/Y2 & X2/Y3

TEST	TEST METH	HOD	PROCEDURE	REQUIREMENTS
Solderability	4.10		Unmounted chips completely immersed in a solder bath at 235 \pm 5 °C	The termination shall be well tinned
			Dipping time: 2 ±0.5 seconds	
			Depth of immersion: 10 mm	
Damp Heat vith U _r Load		4.13	Initial measurements; after 150 +0/-10 °C for 1 hour, then keep for 24 ±1 hours at room temperature	∆C/C NP0: ≤ 2% or 1 pF whichever is greater
			Duration and conditions: 500 \pm 12 hours at 40 \pm 2 °C;	X7R: ≤ 15% D.F.
			90 to 95% RH; 1.0 Ur applied Final measurement: perform a heat treatment at 150 +0/–10 °C for 1 hour, final measurements shall be carried out 24 ±1 hours after recovery at room temperature without load	NP0: ≤ 2 x specified value X7R: ≥ 100V: ≤ 5%
				Rins NP0: ≥ 2,500 MΩ or Rins x Cr ≥ 25s whichever is less
				X7R: ≥ 500 MΩ or Rins x Cr ≥ 25s whichever is less
Endurance	EN132400	4.14 SC	Perform shear test, substrate bending test, impulse voltage and then endurance test progressively	Visual examination
			Same as the above except for 1.25 Ur for X-capacitor and 1.7 Ur for Y-capacitor	DC/C < ± 20%
			Once every hour the voltage shall be increased to 1000 VAC for 0.1 s	Voltage proof
			Total time take to change over to 1000 VAC and back does not exceed 30 s	IR > 3 ×10E9 Ω
mpulse		4.13 SC	XI: 4.0 KV, X2: 2.5 KV	No breakdown or flashover
Voltage		IEC- 60384-14	Y2: 5.0 KV, Y3: None If any three successive impulses are shown by the oscilloscope monitor to have had a waveform indicating that no self-healing breakdowns or flashovers have taken place in the capacitor, then no further impulses shall be applied and the capacitor shall be counted as conforming.	
			24 impulses have been applied to the capacitor and 3 or more of them are of a waveform indicating that no self-heating breakdowns or flashovers have occurred.	
			Time between impulses shall not be less than 10 s	
Robustness of Fermination		4.3 SC	a. A force applied for 10 sec to the line joining the terminations and in a plane parallel to the substrate.	a. No visible damage
(Pull Strength)			b. A force applied until broken	b. Force size \geq 0603: \geq 5N
Voltage Proof		4.2.1 SC	X capacitor: Applied voltage I.075K VDC (4.3 Ur) Y capacitor: Applied voltage I.5K VAC	No breakdown or flashover



9 10

Product specification

 YAGEO
 Product specification
 10

 Surface-Mount Ceramic Multilayer Capacitors
 Safety Certification
 NP0/X7R
 X1/Y2 & X2/Y3
 10

REVISION HISTORY

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version 6	Jan. 27, 2015	-	- Capacitance range update
Version 5	Dec. 16, 2013	-	- impulse voltage update
Version 4	Apr 06, 2011	-	- X2/Y3 UL certification removed
Version 3	Oct 20, 2010	-	- Impulse voltage coding rule updated
Version 2	Feb 06, 2010	-	- The statement of "Halogen Free" on the cover added
Version I	Oct 30, 2009	-	- Define global part number
			- Product range updated
			- Description of "Halogen Free compliant" added
			- Test method and procedure updated
Version 0	Mar I, 2007		- New datasheet for high voltage NP0/X7R series with lead-free terminations

